

FMV16N50ES

FUJI POWER MOSFET

Super FAP-E^{3S} series

N-CHANNEL SILICON POWER MOSFET

■ Features

Maintains both low power loss and low noise Lower R_{DS}(on) characteristic More controllable switching dv/dt by gate resistance Smaller V_{GS} ringing waveform during switching Narrow band of the gate threshold voltage (4.2±0.5V) High avalanche durability

Applications

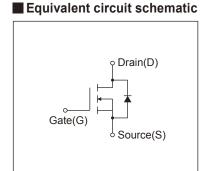
Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

Maximum Ratings and Characteristics

● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

TO-220F(SLS) CONNECTION (m) (m) (m)

■ Outline Drawings [mm]



Description	Symbol	Characteristics	Unit	Remarks
Dunin Common Voltano	V _{DS}	500	V	
Drain-Source Voltage	V _{DSX}	500	V	V _{GS} = -30V
Continuous Drain Current	ID	±16	А	
Pulsed Drain Current	IDP	±64	Α	
Gate-Source Voltage	V _G s	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	Iar	16	А	Note*1
Non-Repetitive Maximum Avalanche Energy	Eas	485	mJ	Note*2
Repetitive Maximum Avalanche Energy	Ear	8	mJ	Note*3
Peak Diode Recovery dV/dt	dV/dt	4.8	kV/μs	Note*4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5
Mandanian Barrer Biratiantian	Po	2.16	14/	Ta=25°C
Maximum Power Dissipation		80	W	Tc=25°C
O	Tch	150	°C	
Operating and Storage Temperature range	Tstg	-55 to + 150	°C	
Isolation Voltage	Viso	2	kVrms	t = 60sec, f = 60H

● Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit	
Drain-Source Breakdown Voltage	BVDSS	I _D =250µA, V _{GS} =0V		500	-	-	V	
Gate Threshold Voltage	V _{GS} (th)	I _D =250µA, V _{DS} =V _{GS}	I _D =250µA, V _{DS} =V _{GS}		4.2	4.7	V	
Zero Gate Voltage Drain Current		V _{DS} =500V, V _{GS} =0V	ch=25°C	-	-	25		
	IDSS	V _{DS} =400V, V _{GS} =0V T	_{ch} =125°C	-	-	250	μA	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V		-	10	100	nA	
Drain-Source On-State Resistance	R _{DS} (on)	I _D =8A, V _{GS} =10V		-	0.33	0.38	Ω	
Forward Transconductance	g _{fs}	I _D =8A, V _{DS} =25V		5.5	11	-	S	
Input Capacitance	Ciss	V _{DS} =25V V _{GS} =0V f=1MHz		-	1700	2550	pF	
Output Capacitance	Coss			-	210	315		
Reverse Transfer Capacitance	Crss			-	13	19.5		
Turn-On Time	td(on)	V _{cc} =300V V _{GS} =10V I _D =8A R _{GS} =18Ω		-	37	55.5	ns	
	tr			-	30	45		
Turn-Off Time	td(off)			-	87	130.5		
	tf			-	17	25.5		
Total Gate Charge	Q _G	V 050V	V 050V		48	72	nC	
Gate-Source Charge	Q _{GS}	- V _∞ =250V - I _D =16A - V _{GS} =10V		-	17	25.5		
Gate-Drain Charge	Q _{GD}			-	18	27		
Gate-Drain Crossover Charge	Qsw			-	7	10.5		
Avalanche Capability	lav	L=1.52mH, Tch=25°C		16	-	-	Α	
Diode Forward On-Voltage	V _{SD}	I _F =16A, V _{GS} =0V, T _{ch} =25°C		-	0.90	1.35	V	
Reverse Recovery Time	trr	I _F =16A, V _{GS} =0V		-	0.46	-	μs	
Reverse Recovery Charge	Qrr	-di/dt=100A/μs, Tch=25°C		-	6.0	-	μC	

Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			1.560	°C/W
	Rth (ch-a)	Channel to Ambient			58.0	°C/W

Note *1 : Tch≤150°C.

Note '2: Stating Tch=25°C, IAS=7A, L=18.1mH, Vcc=50V, RG=50Ω.

EAS limited by maximum channel temperature and avalanche current.

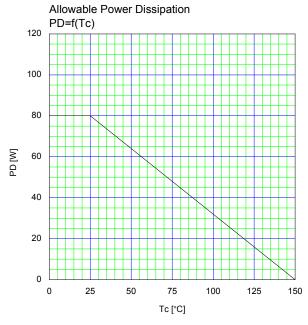
See to 'Avalanche Energy' graph.

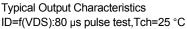
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

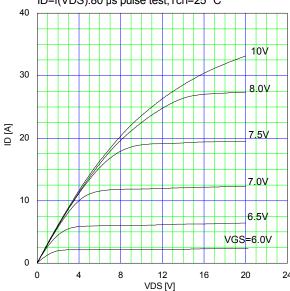
See to the 'Transient Themal impeadance' graph.

Note *4 : IF≤-ID, -di/dt=100A/µs, Vcc≤BVDSS, Tch≤150°C.

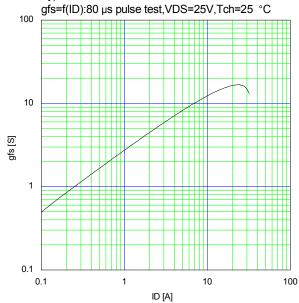
Note *5 : IF≤-ID, dv/dt=4.8kV/µs, Vcc≤BVDSS, Tch≤150°C.



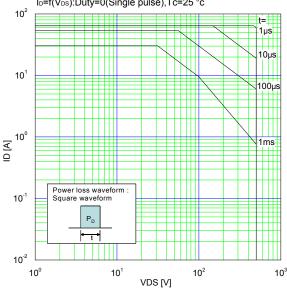




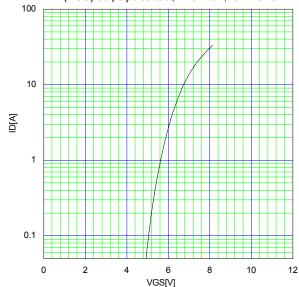
Typical Transconductance



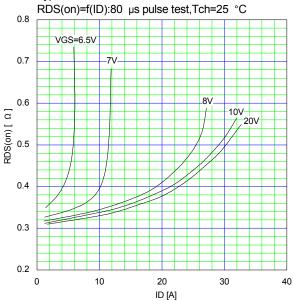
Safe Operating Area $I_D=f(V_{DS})$:Duty=0(Single pulse),Tc=25 °c

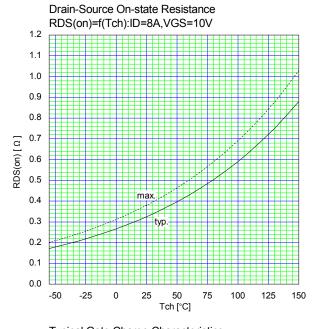


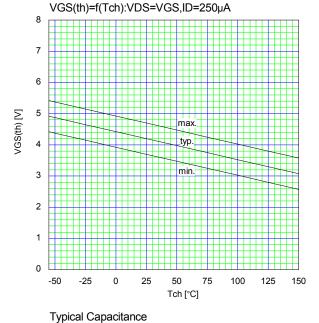
Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25 °C



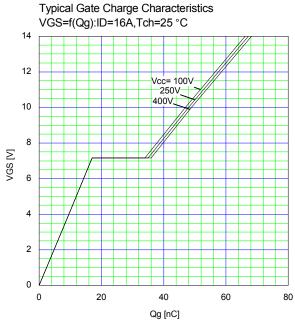
Typical Drain-Source on-state Resistance

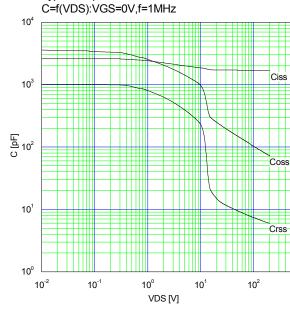


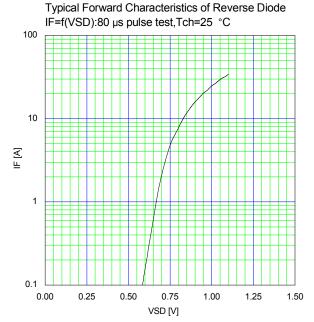


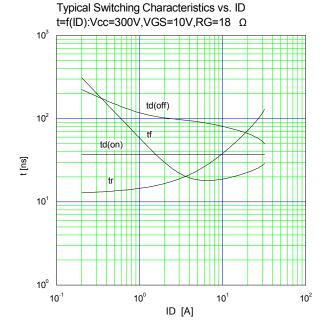


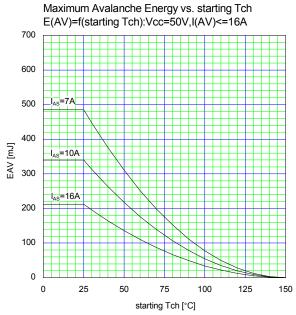
Gate Threshold Voltage vs. Tch

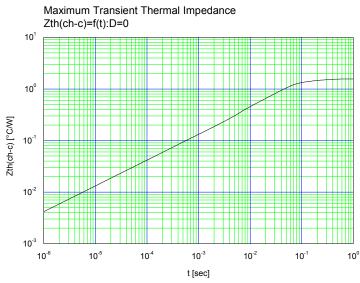












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